

View Online at <https://aerobasegroup.com/nsn/8040-01-106-0036>

**Physical Form:**

Liquid

**Quantity Within Each Unit Package:**

200.000 grams

**Specific Usage Design:**

For bonding semiconductors and components to chassis or heat sinks and other applications

**Features Provided:**

Separate catalyst

**Special Features:**

Thermally conductive

**Color:**

Blue

**Material:**

Plastic epoxy

**Supplementary Features:**

200 gram kit

**Shelf Life:**

N/a

**Unit Of Measure:**

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**Demilitarization:**

No

**Fig:**

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